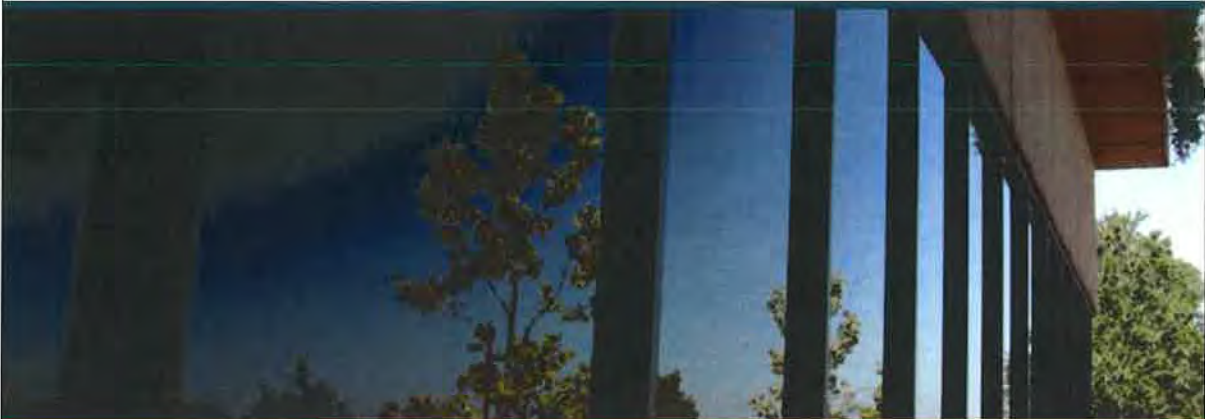


How printing technologies can change the electronics industry



Ross Bringans
PARC, A Xerox Company
bringans@parc.com

About PARC

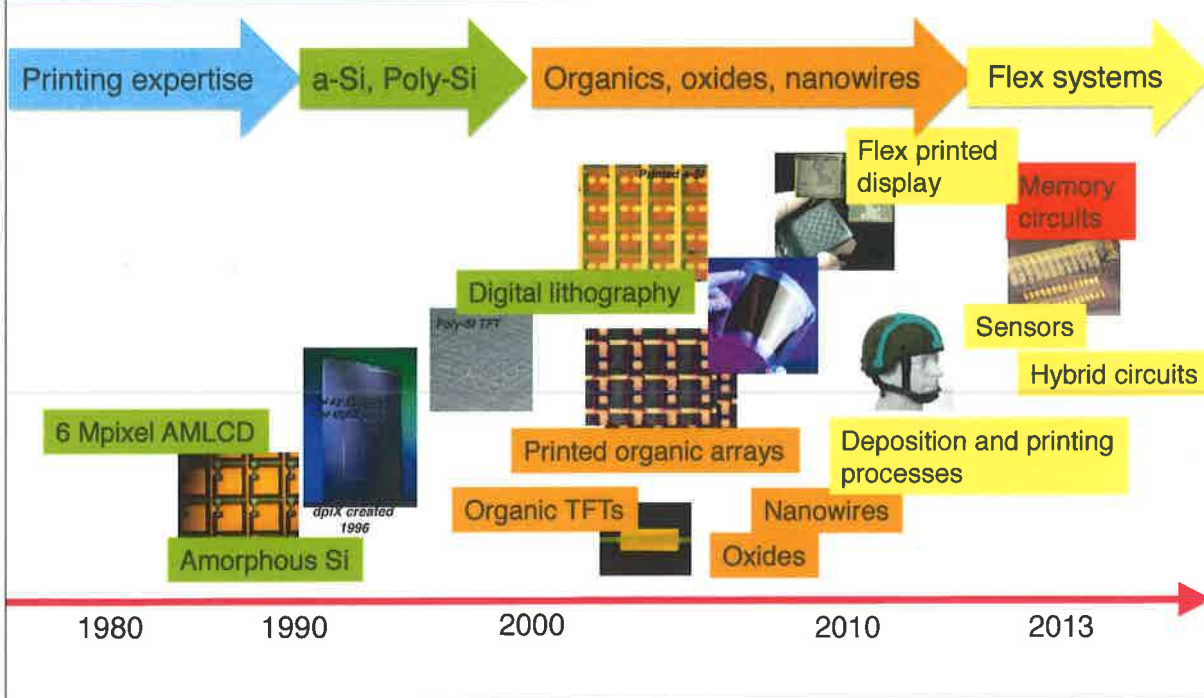
Founded in 1970 as Xerox Palo Alto Research Center

Spun out in 2002 as an independent research business.

PARC history

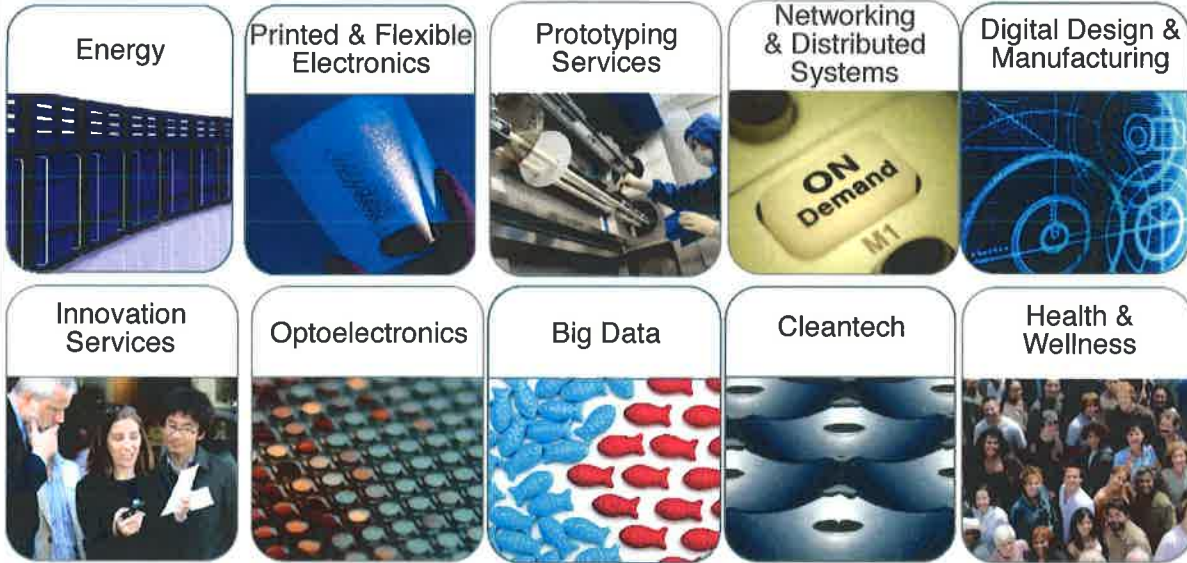
founded 1970	laser printing	PC workstation	Ethernet	WYSIWYG, GUI
corporate ethnography	multi-beam laser diodes	ubiquitous computing	collaborative filtering	AI/ model-based systems
incorporated 2002	UVLEDs	cleantech	printed & flexible electronics	content-centric networking

Large Area and Printed Electronics



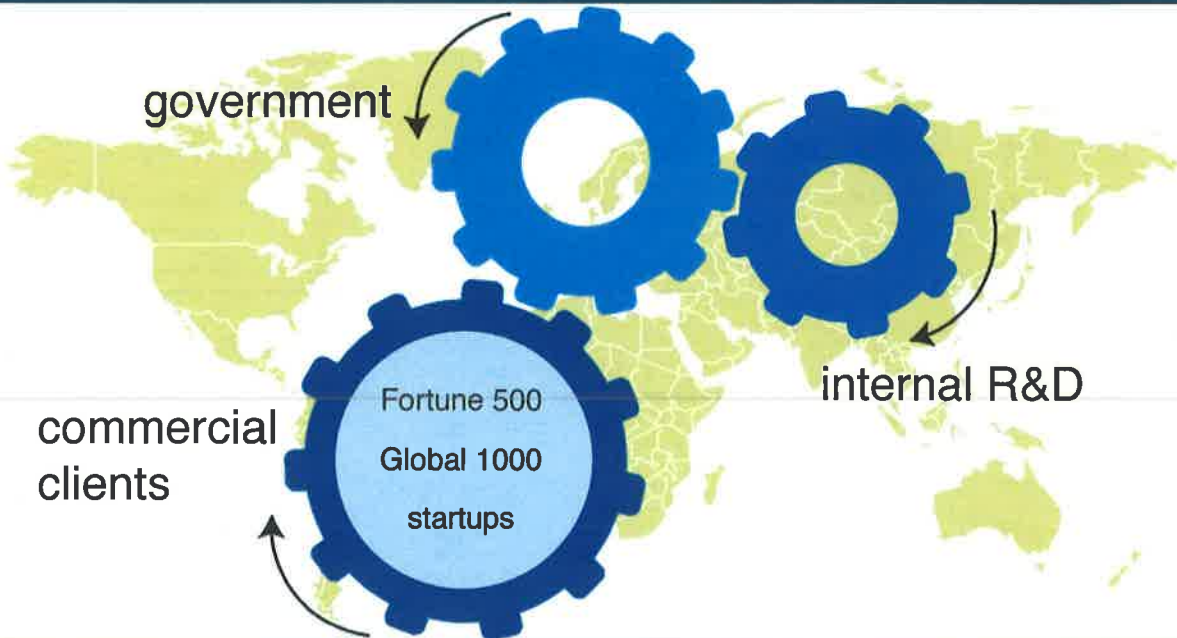
PARC now

The Business of Breakthroughs®



PARC | 5

PARC's open innovation business model



Introduction

- How can the world of manufacturing be changed
 - Democratization of manufacturing
 - Mass customization
 - Just in time delivery
 - How can the printing business be expanded
 - Higher value “prints”
 - Completely new markets
-

For printers, there are some familiar challenges

- Custom at the same price as traditional
 - Quality that meets the requirements
 - Speed
 - Skills mix
 - Installed base
-

Outline

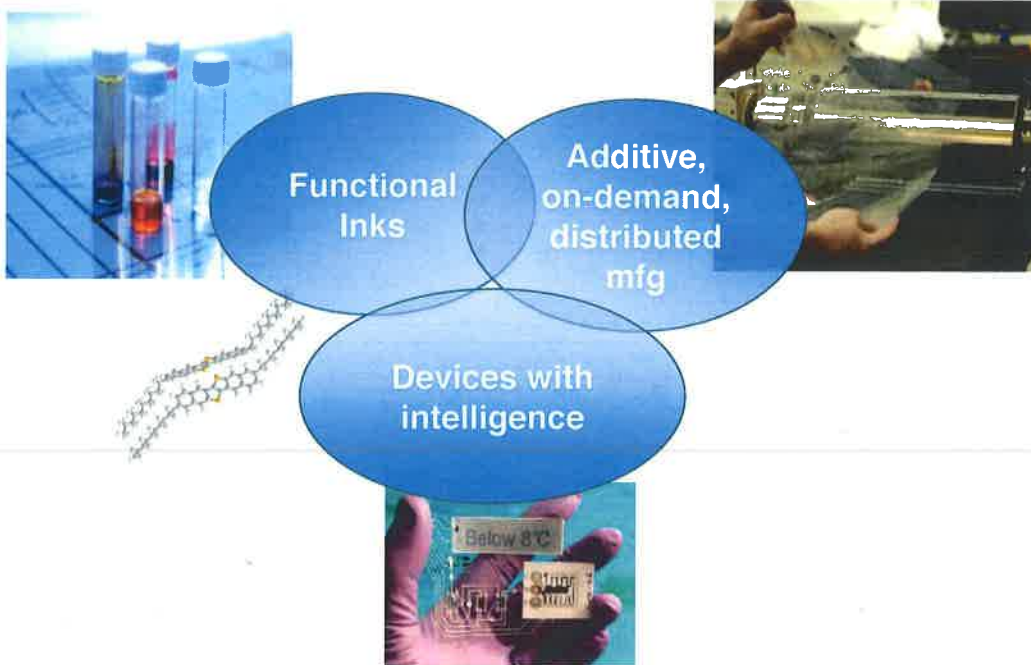
- Printed

- Screen
- Inkjet
- Gravure
- Offset
- Flexo
- Aerosol
- Extrusion
- 3D

- Electronics

- Conductors
- Passives
- Semiconductors
- Transistors
- Circuits
- 2D systems
- On 3D systems
- In 3D systems
- Optical devices
- (and chips)

Printed Intelligence



Images clockwise: Functional inks used at PARC, Gravure printing at PARC, Thin Film Electronics ASA

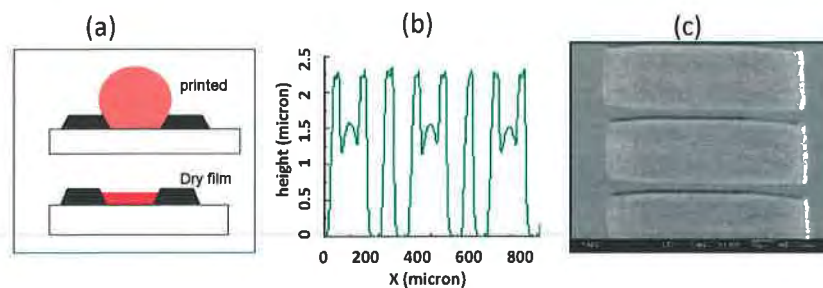
Why are people excited?



23

parc

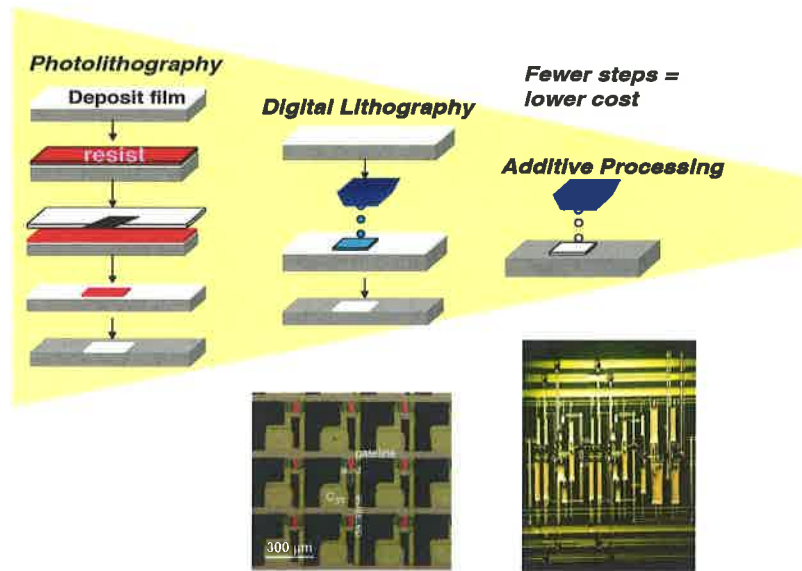
Printing can be used for: 1. Dispensing



Ink deposited into wells

Printing can be used for:

2. Patterning



Printing can be used for:

3. Assembly

Expensive serial assembly



Replaced by low cost parallel automation thru printing "chips as ink"



Printing can be used for:

4. Building

3D Printing

- Plastics, metals,



Images: pixabay.com; commons.wikimedia.org

Printing can be used for:

5. Just-in-time manufacturing

NASA goal:

- digitally manufactured sensor systems
- On-site, on-demand, additively manufactured
- Light weight, customizable, distributed sensor systems



Jet Propulsion Laboratory
California Institute of Technology



A Xerox Company



And, printing promises: 6. Ability to make Really Complex Systems

Current state of the art



- Degree of Integration
- Sensor density

European Framework SmartHand project



Integrated Object Printer

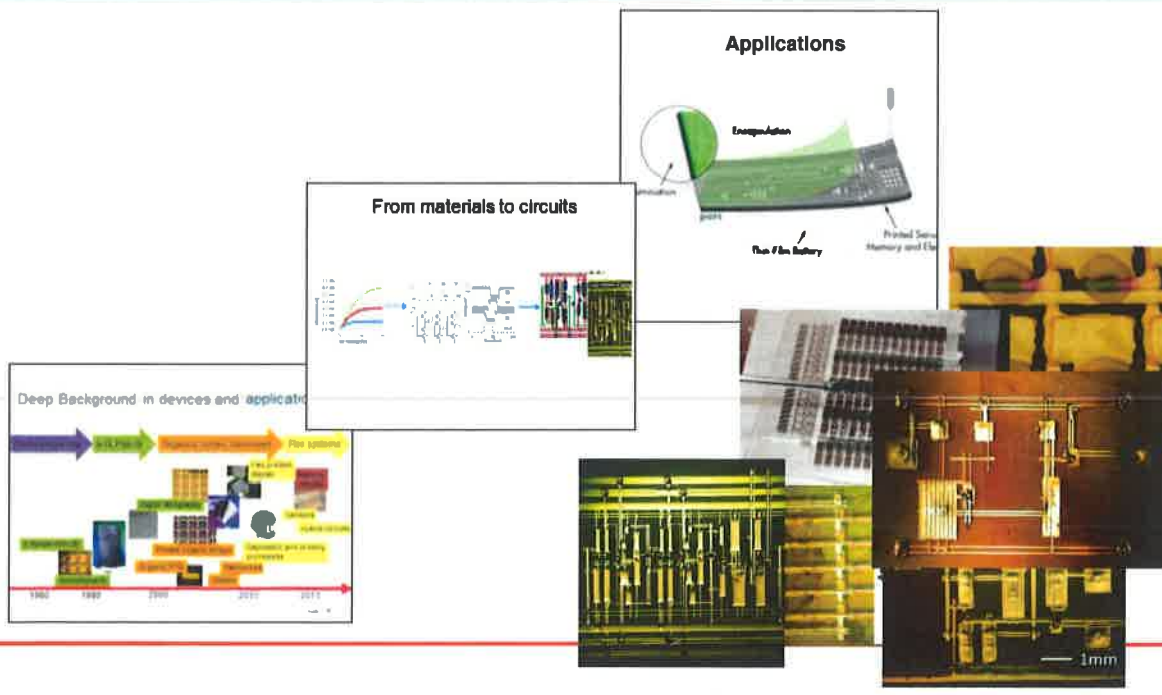
Integrated high density sensors

Integrated complex motor function

In nature

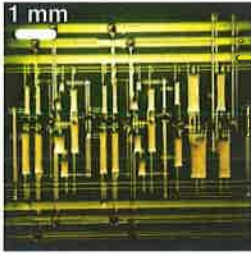


From Materials to Systems

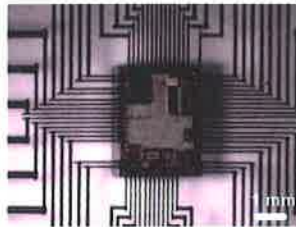


Approaches to Printing Electronics

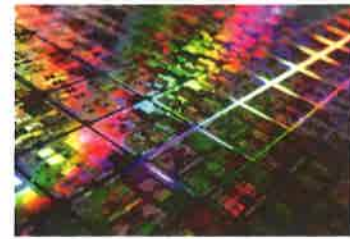
all-printed: all components printed from simple inks



hybrid: include some pre-fabricated components if needed



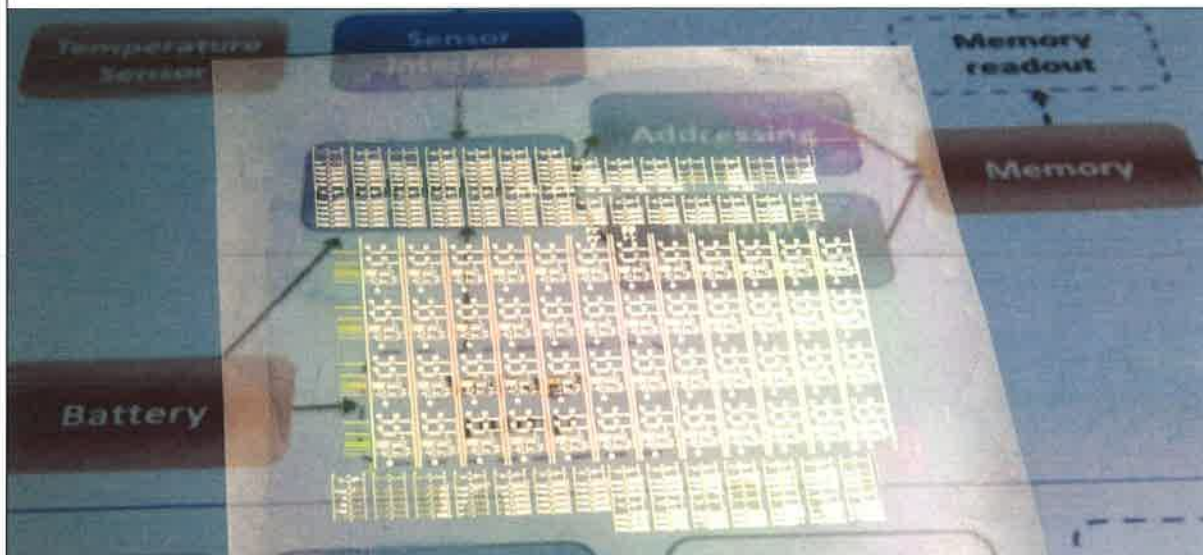
assembly: large scale assembly of electronic components



increasing performance, size of materials set, cost →

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1. All-printed Electronics



Printed conductors – already here

- RFID antennae
- Membrane switches for keypads
- Touchpads
- Automotive mirror defrosters
- Medical sensors e.g. EKG, EEG.



Gravure printing of electronic structures on paper. (Wikimedia commons)



T-Ink



Copyright PolyIC

New directions in printed conductors

- Low temperature inks and high temperature papers
 - Nano particles
 - Coated paper



Xerox Research Center Canada

<http://www.xrcc.external.xerox.com>

Arjowiggins

- Printing on 3D structures – Optomec examples

<http://www.optomec.com>



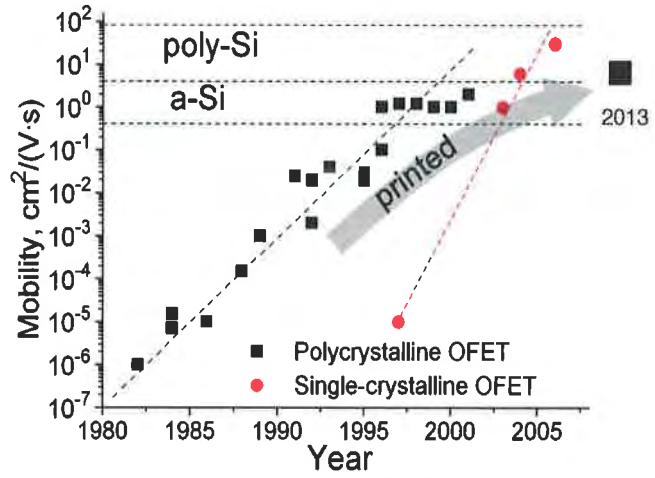
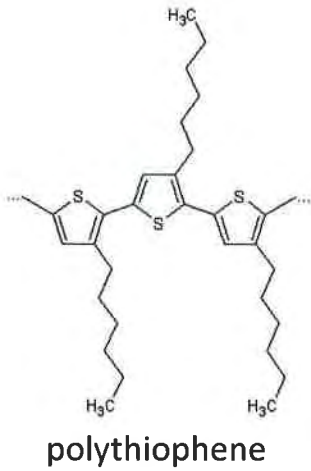
SUBSTRATE:
CERAMIC CUBE
INK:
Ag NANOPARTICLE
POST PROCESSING:
THERMAL 120C TO 180C



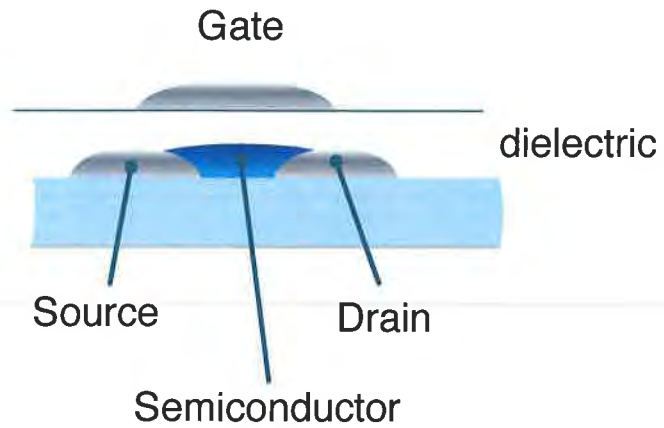
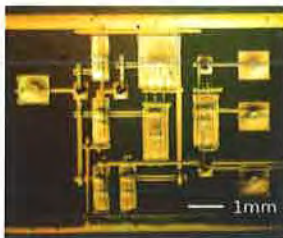
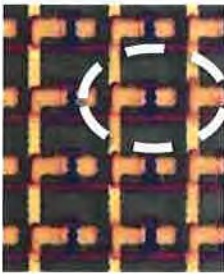
SUBSTRATE:
STACKED SILICON DIES AND EPOXY
CIRCUIT BOARD
PRINTED INK:
Ag NANOPARTICLE
POST PROCESS:
THERMAL AT 220°C
PHOTO COURTESY OF VERTICAL
CIRCUITS INC.



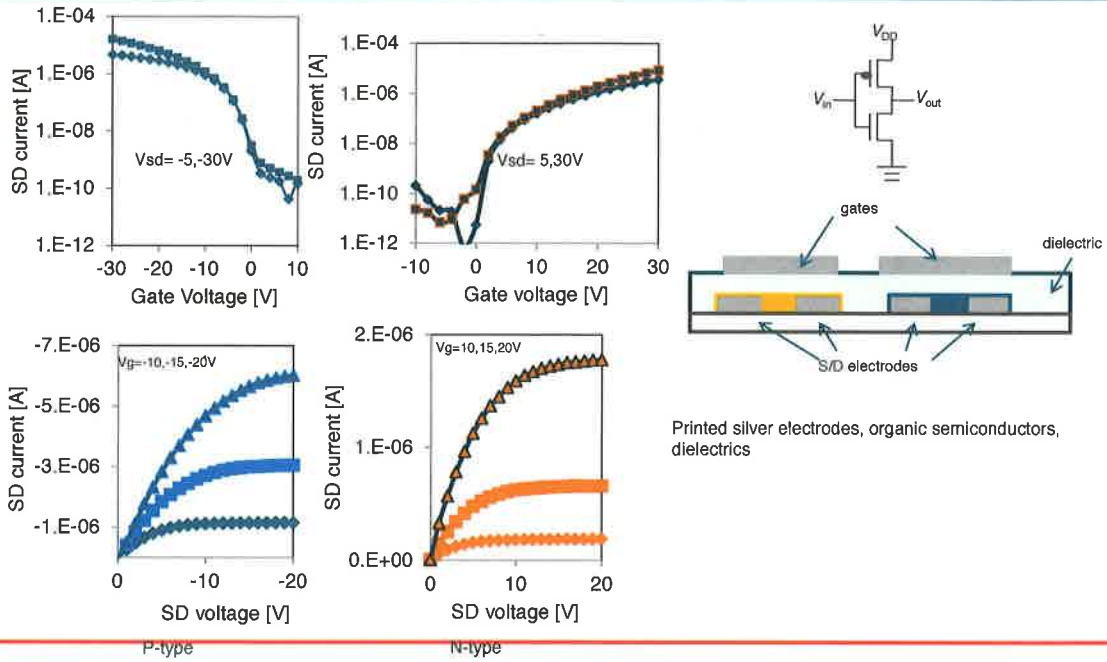
Printed semiconductors



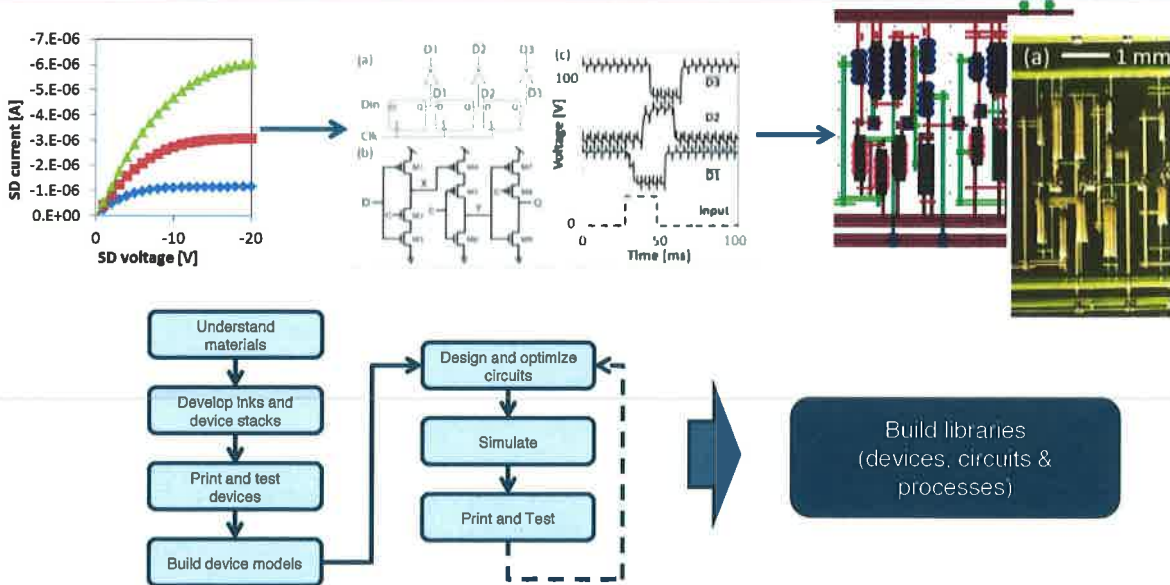
The foundational device: Printed Thin Film Transistor (TFT)



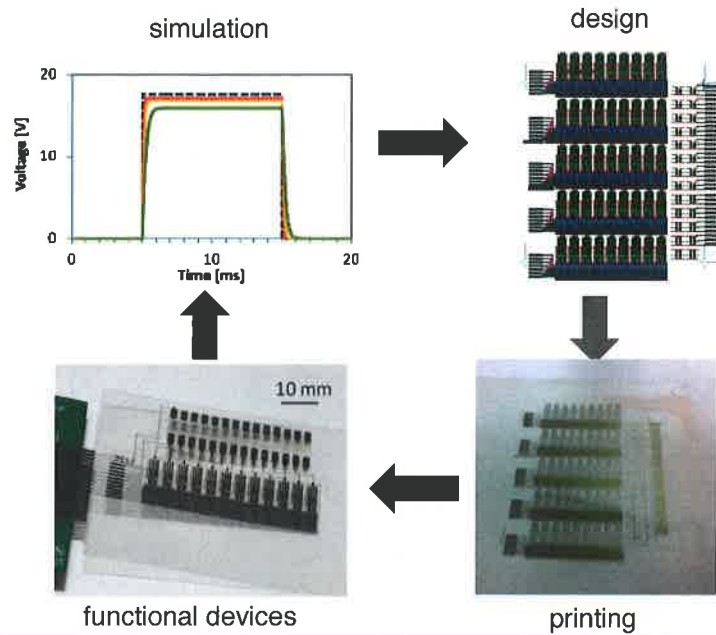
Printed complementary TFTs



From materials to circuits

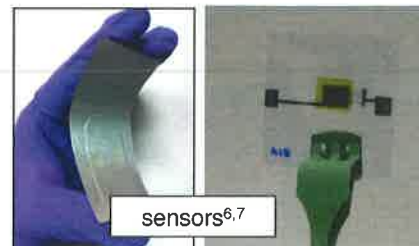
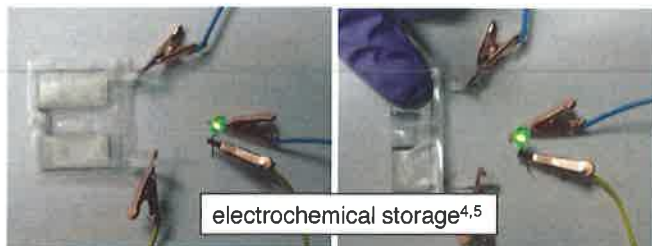
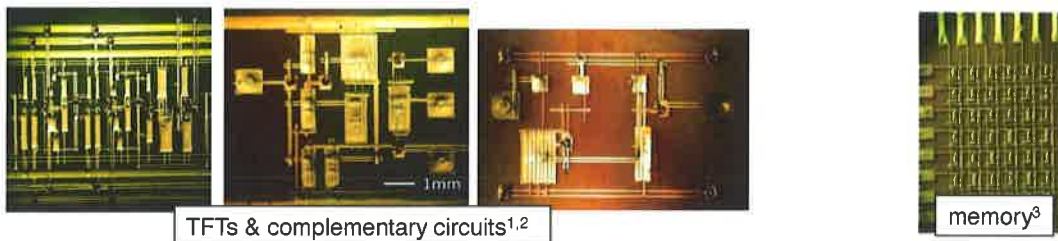


Development Cycle



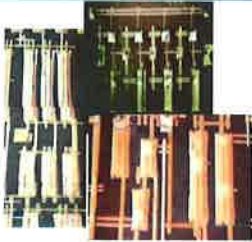
All-Printed Devices

Many device types can be printed from simple inks



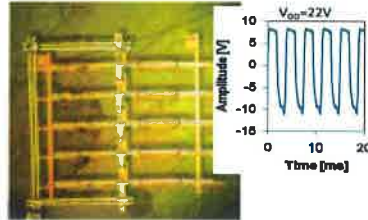
¹APL, 2009, 253302; ²IEEE Electron Dev. Lett., 34, 2013, 271; ³JAP 2009, 094504; ⁴Adv. Mater., 2011, 3251, ⁵APL, 2013, 233302; ⁶Org. Electron. 2011, 682; ⁷APL 2013, 103308

An expanding library: printed logic

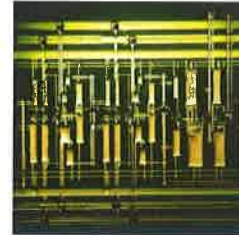


AND, OR, NOT, NAND

Boolean logic



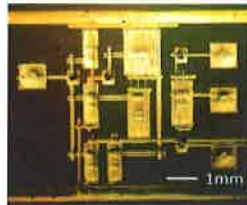
Ring oscillator



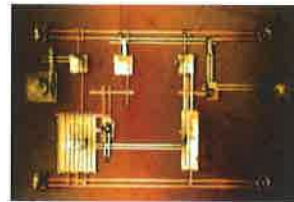
Shift register



Decoder



Pulse generator



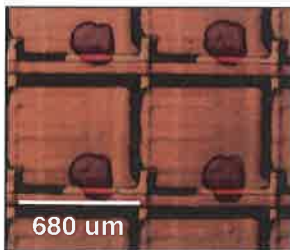
Trigger with half latch



Memristor

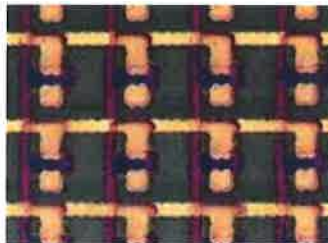
An expanding library: printed arrays

Active matrix display



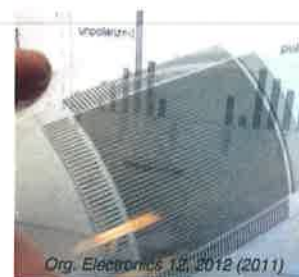
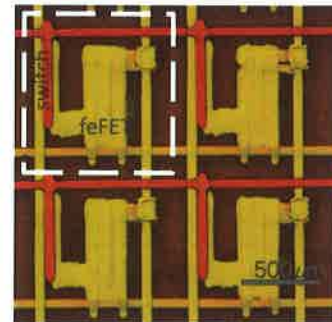
J. Soc. Info. Display 2007, 7, 485-490

Image sensor arrays



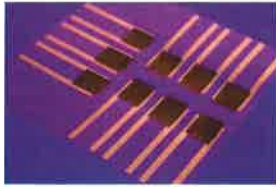
Appl. Phys. Lett. 92, 213303 (2008)

Memory arrays

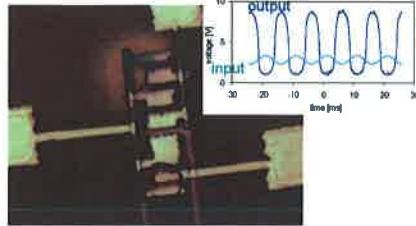


Org. Electronics 10, 2012 (2011)

An expanding library: sensors & interface



Temperature sensor



Amplifier



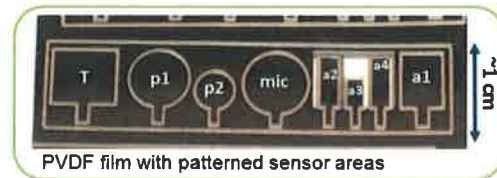
Flex battery



Light sensor



Pressure sensor

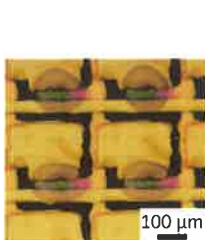


PVDF film with patterned sensor areas

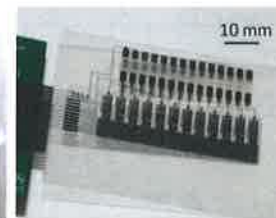
MEMS (acceleration, acoustic)

Applications for All-Printed Circuits

Many different applications



Ink-jet printed active matrix backplanes and displays¹



addressing systems²
(developed with Thin Film Electronics)

¹J. Soc. Inf. Display 2007, 485, ²Sci. Rep., 2, 2012, 585